# High Performance BGA Cooling Solutions w/ Thermal Tape Attachment





ATS Part#: ATS-54325W-C1-R0

Description: High Performance Extrusion, T412, BLACK-ANODIZED

Heat Sink Type: Straight Fin
Heat Sink Attachment: THERMAL TAPE
Equivalent Part Number: ATS-54325W-C2-R0

\*Image above is for illustration purpose only.

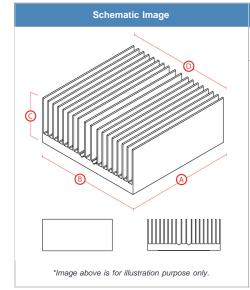
## **Features & Benefits**

- · High aspect ratio, straight fin heat sinks that are ideal for compact PCB environments
- · Designed specifically for BGAs and other surface mount packages
- · Comes pre-assembled with high performance thermal interface material

#### **Thermal Performance**

AIR VELOCITY		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	3.12 °C/W	2.36 °C/W	2.01 °C/W	1.80 °C/W	1.65 °C/W	1.53 °C/W	1.44 °C/W
	Ducted Flow	1.86	n/a	n/a	n/a	n/a	n/a	n/a

### **Product Detail**



Dimension A	Dimension B	Dimension C	Dimension D	TIM	Finish
32.5 mm	32.5 mm	24.5 mm	mm	T412	BLACK-ANODIZED

#### Notes:

- Dimension A and B refer to component size.
- Dimension C is the heat sink height from the bottom of the base to the top of the fin field.
- ATS-54325W-C2-R0 is the exact heat sink assembly with an equivalent thermal interface material (Saint Gobain C675).
- Thermal performance data are provided for reference only. Actual performance may vary by application.
- ATS reserves the right to update or change its products without notice to improve the design or performance.
- ATS certifies that this heat sink assembly is RoHS-6 and REACH compliant.
- Contact ATS to learn about custom options available.

